16 2814

ATTORNEY DOCKET NO: AMKOR-052RCE
TITLE: LEADFRAME AND SEMICONDUCTOR PACKAGE WITH IMPROVED
SOLDER JOINT STRENGTH

Certificate of Mailing under 37 CFR 1.8 or 37 CFR 1.10

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PTO/SB/21 (09-04)

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(to be used for all correspondence after initial filing)

Application Number 09/687,048

Filing Date 10/13/2000

First Named Inventor Tae Heon Lee

Art Unit 2814

Examiner Name Nguyen, Dilinh P.

Attorney Docket Number AMKOR-052RCE

101	al Number of Pages in This Submission		1.33.					
ENCLOSURES (Check all that apply)								
	Fee Transmittal Form Fee Attached Amendment/Reply After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Request Information Disclosure Statement Certified Copy of Priority Document(s) Reply to Missing Parts/ Incomplete Application Reply to Missing Parts under 37 CFR 1.52 or 1.53	Drawing(s) Licensing-related Papers Petition Petition to Convert to a Provisional Application Power of Attorney, Revocal Change of Correspondence Terminal Disclaimer Request for Refund CD, Number of CD(s) Landscape Table on C	e Address	After Allowance Communication to TC Appeal Communication to Board of Appeals and Interferences Appeal Communication to TC (Appeal Notice, Brief, Reply Brief) Proprietary Information Status Letter X Other Enclosure(s) (please Identify below): Certificate of Mailing; and Return Receipt Postcard				
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Application No.: 09/687,048

Attorney Docket: AMKOR-052RCE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

	Tae Heon Lee)	Confirmation No.	1120
Serial No.:	09/687,048)	Art Unit:	2814
Filed:	10/13/2000)	Examiner:	Nguyen Dilinh F
For:	Leadframe and Semiconductor Package With Improved Solder Joint Strength)		

AMENDMENT IN RESPONSE TO OFFICE ACTION

Mail Stop AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir/Madam:

In response to the Office Action mailed October 5, 2005 in relation to the above-identified patent application, please amend the above-identified application as follows: